PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tetsuro MIYAMOTO	01/08/2010
Yoshishige ENDO	01/08/2010
Shigenori TOGASHI	01/07/2010
Erika KATAYAMA	01/08/2010

RECEIVING PARTY DATA

Name:	Hitachi Plant Technologies, Ltd.	
Street Address:	5-2, Higashi-Ikebukuro 4-chome, Toshima-ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12708070

CORRESPONDENCE DATA

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TTORNEY DOCKET NUMBER: 500.50585X00	
NAME OF SUBMITTER:	Alan E. Schiavelli

Total Attachments: 1

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REEL: 023955 FRAME: 0780

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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi Plant Technologies, Ltd., a corporation organized under the laws of Japan, located at 5-2, Higashi-Ikebukuro 4-chome, Toshima-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said. Hitachi Plant Technologies, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi Plant Technologies, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Plant Technologies, Ltd.

Signed on the date(s) indicated aside signatures:

RECORDED: 02/18/2010

	INVENTOR(S)	Date Signed
	(発明者フルネームサイン)	(署名日)
1)	Jetsuro Miyamoto Tetsuro MIYAMOTO	1/8/2010
2) _	Spokiskie Cendo Yoshishige ENDO	1/8/2010
3)	Shigenori Togashi Shigenori TOGASHI	1/7/20/0
4) _	Erika Kacagoma	1(8/2010
5)	Erika KATAYAMA	
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7)		
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9)		
10)		

PATENT REEL: 023955 FRAME: 0781